

## PATENT ASSIGNMENT COVER SHEET

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
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	<b>Property Type</b>	<b>Number</b>
	Application Number:	16785805
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<b>DATE SIGNED:</b>	02/10/2020	
<b>Total Attachments: 3</b>		
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## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	38536131
<b>Application Number:</b>	16785805
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	9993
<b>Title of Invention:</b>	INTERCHANGEABLE MOUNTING PLATFORM
<b>First Named Inventor/Applicant Name:</b>	Paul PAN
<b>Customer Number:</b>	136725
<b>Filer:</b>	Li Jiang/Jiacheng Wei
<b>Filer Authorized By:</b>	Li Jiang
<b>Attorney Docket Number:</b>	00203.1232.02US
<b>Receipt Date:</b>	10-FEB-2020
<b>Filing Date:</b>	
<b>Time Stamp:</b>	11:28:44
<b>Application Type:</b>	Utility under 35 USC 111(a)

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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Transmittal of New Application	Transmittal00203123202.pdf	319821	no	2
			9274d5a219bb4dc960606425aa1a594adc6 affeb		

### Warnings:

**PATENT**

**REEL: 051861 FRAME: 0124**

Information:					
2	Application Data Sheet	ADS00203123202.pdf	1823277	no	9
			2e5f214e4d67cf9ba3256165117a0376a73a1cf		
Warnings:					
Information:					
3		Spec00203123202.pdf	277487	yes	61
			97fd2e9c30f140a27262dd10403e0ac2151a1f4c		
	Multipart Description/PDF files in .zip description				
	Document Description		Start	End	
	Specification		1	59	
	Claims		60	60	
	Abstract		61	61	
Warnings:					
Information:					
4	Drawings-only black and white line drawings	Draw00203123202.pdf	2145665	no	37
			42be67ed58f8faebda6c803b2f8c1b6ad4853d64		
Warnings:					
Information:					
5	Oath or Declaration filed	Dec00203123202.pdf	167452	no	3
			c0086d06b4766afe94741cd845eadff211fa9ee4		
Warnings:					
Information:					
6	Power of Attorney	POA00203123202.pdf	246672	no	2
			5f783aa4bb9c46ffb0a9b5fdab8c5bf9dc615147		
Warnings:					
Information:					
7	Transmittal Letter	TransSubmissionIDS123202.pdf	78263	no	2
			3fe54b476966d68cbb880e3c8c547e58681aaf25		

<b>Warnings:</b>					
<b>Information:</b>					
8	Information Disclosure Statement (IDS) Form (SB08)	1IDS00203123202.pdf	1039250  c5fedfdb611d87def9b27985539d5742721d4e91	no	14
<b>Warnings:</b>					
<b>Information:</b>					
9	Information Disclosure Statement (IDS) Form (SB08)	2IDS00203123202.pdf	1035978  294198a2582e4fe003576edce80f0e6227be472c	no	5
<b>Warnings:</b>					
<b>Information:</b>					
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<b>Total Files Size (in bytes):</b>			7133865		
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